



100V N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI[®]

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	110mΩ @ V _{GS} = 10V	3.4 A
100V	122mΩ @ V _{GS} = 6.0V	3.2 A

Description

This MOSFET has been designed to minimize the on-state resistance $(R_{DS(on)})$ and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

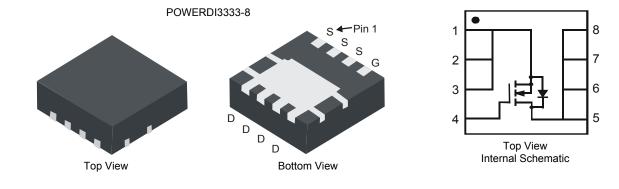
- Power Management Functions
- DC-DC Converters

Features and Benefits

- Low R_{DS(ON)} ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
 Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.008 grams (approximate)



Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMN10H120SFG-7	Standard	POWERDI3333-8	2000/Tape & Reel
DMN10H120SFG-13	Standard	POWERDI3333-8	3000/Tape & Reel

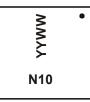
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

 See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



N10 = Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year (ex: 13 = 2013) WW = Week code (01 ~ 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage		V _{DSS}	100	V	
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 6))/ = 10)/	Steady State	T _A = +25°C T _A = +70°C	ID	3.4 2.6	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t<10s	T _A = +25°C T _A = +70°C	ID	4.8 3.7	А
	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	ID	3.2 2.5	А
Continuous Drain Current (Note 6) V _{GS} = 6V	t<10s	T _A = +25°C T _A = +70°C	ID	4.6 3.6	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	20	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	_	Symbol	Value	Units
Tatal Davies Disaination (Nata C)	T _A = +25°C		1.0	W
Total Power Dissipation (Note 5)	T _A = +70°C	PD	0.6	
Thermal Desistance Junction to Ambient (Note 5)	Steady state	D	131	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	R _{0JA}	76	
Tatal Dawar Dissinction (Nata 6)	T _A = +25°C	D	2.3	W
Total Power Dissipation (Note 6)	T _A = +70°C	PD	1.2	
Thermal Desistance Junction to Ambient (Note 6)	Steady state	D	55	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	28	
Thermal Resistance, Junction to Case (Note 6)	$R_{\theta JC}$	6.9		
Operating and Storage Temperature Range		T _{J.} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	-	-	V	$V_{GS} = 0V, I_D = 250 \ \mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	-	-	1.0	μA	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	-	-	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(th)}	1.5	2.0	3.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance	Pro (out)	-	68	110	mΩ	V _{GS} = 10V, I _D = 3.3A	
	R _{DS (ON)}	-	75	122	11152	V _{GS} = 6.0V, I _D = 3.0A	
Forward Transfer Admittance	Y _{fs}	-	13	-	S	V _{DS} = 10V, I _D = 3.3A	
Diode Forward Voltage	V _{SD}	-	0.78	-	V	$V_{GS} = 0V, I_{S} = 3.2A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	-	549	-	pF		
Output Capacitance	C _{oss}	-	41.1	-	pF	V _{DS} = 50V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	-	19.0	-	pF		
Gate Resistance	R _g	-	1.6	-	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge V _{GS} = 10V	Qg	-	10.6	-	nC		
Total Gate Charge V _{GS} = 4.5V	Qg	-	5.2	-	nC		
Gate-Source Charge	Q _{gs}	-	2.3	-	nC	V _{DS} = 50V, I _D = 3.3A	
Gate-Drain Charge	Q _{gd}	-	2.6	-	nC	1	
Turn-On Delay Time	t _{D(on)}	-	3.8	-	ns		
Turn-On Rise Time	tr	-	1.8	-	ns	V _{GS} = 10V, V _{DS} = 50V,	
Turn-Off Delay Time	t _{D(off)}	-	11.5	-	ns	R _G = 6.0Ω, I _D = 3.3A	
Turn-Off Fall Time	t _f	-	2.5	-	ns		

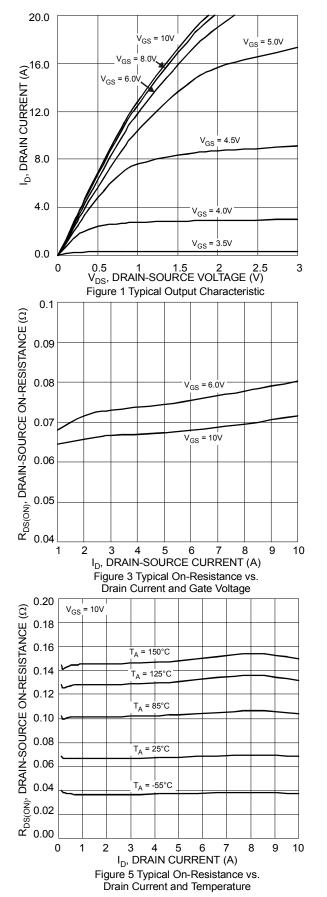
Notes:

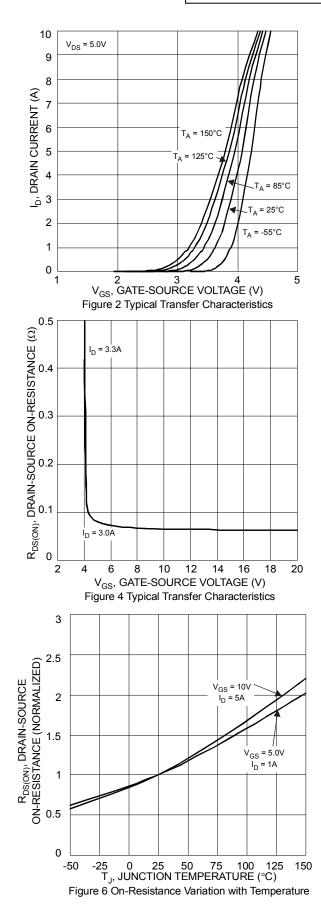
Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

8. Guaranteed by design. Not subject to product testing



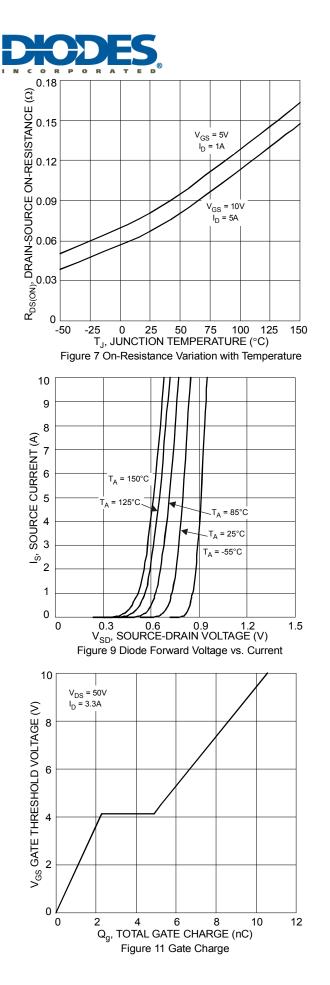
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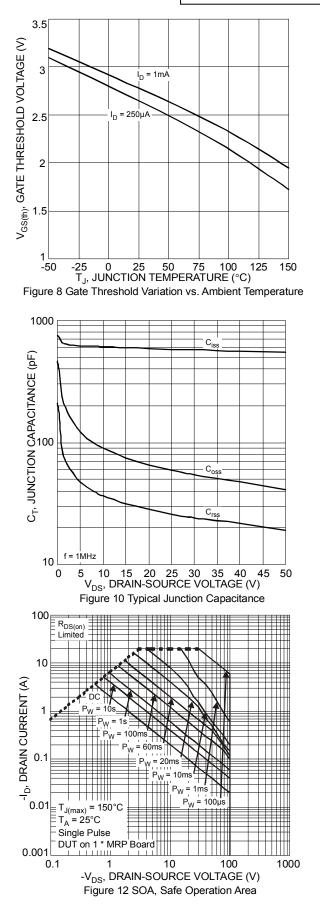




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DMN10H120SFG



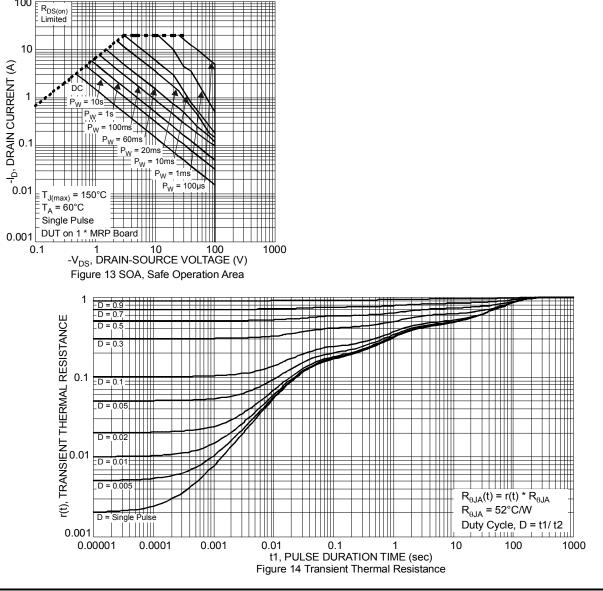


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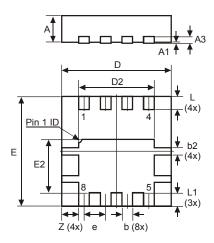


100



Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



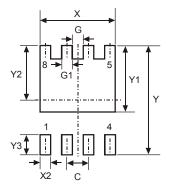
P	POWERDI3333-8					
Dim	Min	Max	Тур			
D	3.25	3.35	3.30			
Е	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
E2	1.56	1.66	1.61			
Α	0.75	75 0.85 0.80				
A1	0	0.05	0.02			
A3	-	-	0.203			
b	0.27	0.37	0.32			
b2	-	- 0.2				
L	0.35	0.45	0.40			
L1	0.3		0.39			
е	_	_	0.65			
Ζ	_	_	0.515			
All I	All Dimensions in mm					

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Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	0.230			
G1	0.420			
Y	3.700			
Y1	2.250			
Y2	1.850			
Y3	0.700			
Х	2.370			
X2	0.420			

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